R@25C:82 DHMS +/-5%
PTC:.7%/C
DPERATING RANGE:-55 TO 100 C
STORAGE RANGE:-65 TO 150 C
\*THERMAL TIME CONSTANT:30 SEC. MAX.
\*DISSIPATION CONSTANT:2.5 mW/C MIN.
POWER RATING:.25W@25 C,DERATE TO 100 \*As tested per MIL-R-23648. vary dependent on mounting TO 100 (C) TEMP 17000 1 1000 1 ) | | | | | | | RESISTANCE MULTIPLIER - - - - 875 500000 RESISTANCE TOLERANCE 197571D ωö % POWER 00

IG. 1: PERFORMANCE CHARACTERISTICS

DEVICE IS NOT SUITABLE FOR MOUNTING
ON FLEXIBLE SUBSTRATES OR WHERE LOADS
ARE PLACED ON THE TERMINATION.

SOLDERING RECOMMENDATIONS:

HAND SOLDERING IS NOT RECCOMENDED, HOWEVER IF NEEDED SOLDERING IRON TIP SHALL NOT EXCEED 250 C

MAXIMUM TEMPERATURE DIFFERENCE BETWEEN SOLDER AND THERMISTOR SHALL BE 150 C

MAXIMUM TEMPERATURE DIFFERENCE BETWEEN SOLVENT FOR IMMERSION AND THERMISTOR SHALL BE 150 C RECOMMENDED REFLOW PEAK=220 TO 230 C, 10 SECONDS MAX.

FIG. 4: SOLDER RECOMMENDATIONS

FIG.

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DIMENSIONS (INCHES)



